

AO4415 30V P-Channel MOSFET

General Description

The AO4415 uses advanced trench technology to provide excellent $R_{DS(ON)}$, and ultra-low low gate charge. This device is suitable for use as a load switch or in PWM applications.

Product Summary

 $V_{DS}(V) = -30V$

 $I_D = -8 \text{ A } (V_{GS} = -20 \text{V})$

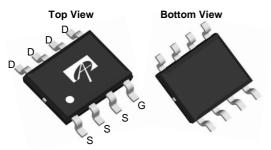
 $R_{DS(ON)}$ < 26m Ω (V_{GS} = -20V)

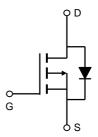
 $R_{DS(ON)} < 35 m\Omega \text{ (V}_{GS} = -10 \text{V)}$

100% UIS Tested 100% Rg Tested









Absolute Maximum	Ratings	T ₄ =25℃ unless	otherwise noted

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Parameter		Symbol	Maximum	Units		
Drain-Source Voltage		V_{DS}	-30	V		
Gate-Source Voltage		V_{GS}	±25	V		
Continuous Drain	T _A =25℃		-8			
Current ^A	T _A =70℃	I _D	-6.6	Α		
Pulsed Drain Current ^B		I _{DM}	-40			
	T _A =25℃	D	3	W		
Power Dissipation ^A	T _A =70℃	P_{D}	2.1) vv		
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	C		

Thermal Characteristics					
Parameter		Symbol	Тур	Max	Units
Maximum Junction-to-Ambient A	t ≤ 10s	В	24	40	℃/W
Maximum Junction-to-Ambient A	Steady-State	$R_{\theta JA}$	54	75	€\M
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	21	30	℃/W

Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC F	PARAMETERS					
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-30			V
	Zero Gate Voltage Drain Current	V _{DS} =-24V, V _{GS} =0V			-1	^
I _{DSS}	Zero Gate Voltage Brain Guirent	$T_{J}=5$	5℃		-5	μΑ
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±25V			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=-250\mu A$	-1.7	-2.8	-3.5	V
$I_{D(ON)}$	On state drain current	V_{GS} =-10V, V_{DS} =-5V	40			Α
R _{DS(ON)} Static Drain-Source On-Resistance		V _{GS} =-20V, I _D =-8A		21.5	26	mΩ
	Static Drain-Source On-Resistance	T _J =12	5℃	29	35	11152
	V _{GS} =-10V, I _D =-8A		28.5	35	mΩ	
		V_{GS} =-6 V , I_D =-5 A		41		mΩ
g _{FS}	Forward Transconductance	V_{DS} =-5V, I_{D} =-8A		11.5		S
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V		-0.76	-1	V
Is	Maximum Body-Diode Continuous Curre	ent			-4.2	Α
DYNAMIC	PARAMETERS					
C _{iss}	Input Capacitance			893	1100	pF
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =-15V, f=1MHz		204		pF
C_{rss}	Reverse Transfer Capacitance			151		pF
R_g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz		4	6	Ω
SWITCHI	NG PARAMETERS					
Q _g (10V)	Total Gate Charge (10V)			16.6	21	nC
Q_{gs}	Gate Source Charge	V_{GS} =-10V, V_{DS} =-15V, I_{D} =-8A		3.2		nC
Q_{gd}	Gate Drain Charge			5.2		nC
t _{D(on)}	Turn-On DelayTime			10.5		ns
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-15V, R_L =1.8	3Ω,	7.3		ns
t _{D(off)}	Turn-Off DelayTime	R_{GEN} =3 Ω		15.1		ns
t _f	Turn-Off Fall Time			8.6		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-8A, dI/dt=100A/μs		21	26	ns
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =-8A, dI/dt=100A/μs		10.7		nC

A: The value of R $_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ =25 $^{\circ}$ C.

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The value in any a given application depends on the user's specific board design. The current rating is based on the t \leq 10s thermal resistance rating.

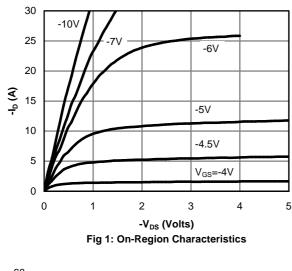
B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using 80 µs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ =25 $^{\circ}$ C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



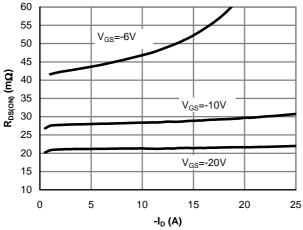
20 15 10 125°C 5 0 2.5 3 3.5 4 4.5 5 5.5 6 6.5

V_{DS}=-5V

25

1.60

-V_{GS}(Volts) Figure 2: Transfer Characteristics



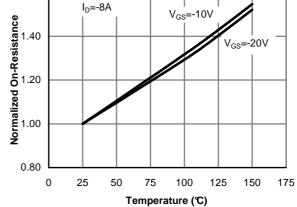
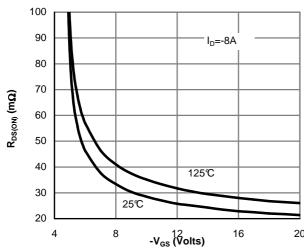


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

Figure 4: On-Resistance vs. Junction Temperature



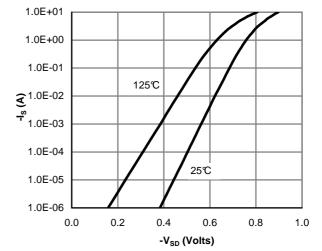


Figure 5: On-Resistance vs. Gate-Source Voltage

Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

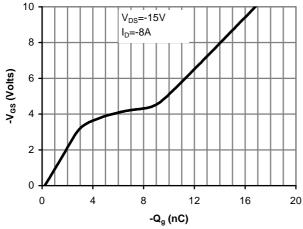


Figure 7: Gate-Charge Characteristics

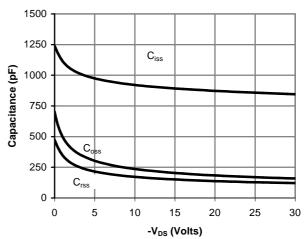


Figure 8: Capacitance Characteristics

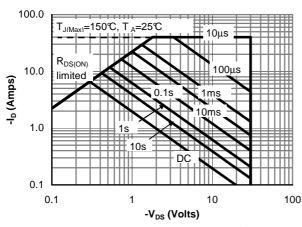


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

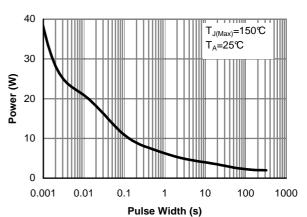


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

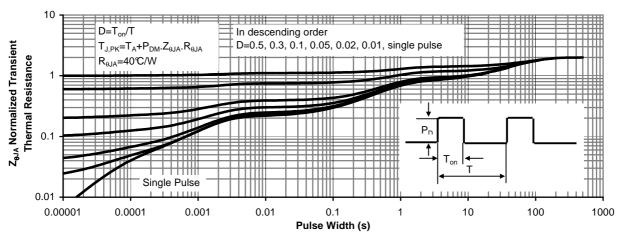


Figure 11: Normalized Maximum Transient Thermal Impedance